

Solid State Relay OCMOS FET

PS710B-1A,PS710BL-1A

6-PIN DIP, $0.05~\Omega$ LOW ON-STATE RESISTANCE 2.5 A CONTINUOUS LOAD CURRENT 1-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

The PS710B-1A and PS710BL-1A are solid state relays containing a GaAs LED input side and MOS FETs on the output side.

It is suitable for PLC, etc. because of its large continuous load current and low on-state resistance.

The PS710BL-1A has a surface mount type lead.

FEATURES

- Low on-state resistance ($R_{on} = 0.05 \Omega \text{ TYP.}$)
- Large continuous load current (I_L = 2.5 A)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- · Low offset voltage
- Ordering number of taping product: PS710BL-1A-E3, E4: 1 000 pcs/reel

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- · Pb-Free product
- Safety standards
 - UL approved: File No. E72422

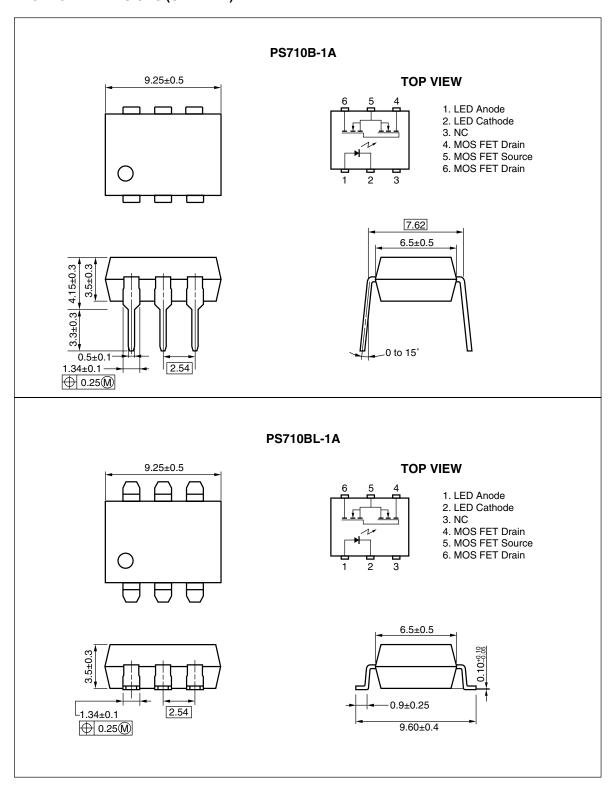
APPLICATIONS

- · Measurement equipment
- FA equipment

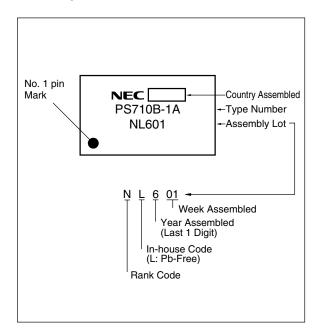
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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number 1
PS710B-1A	PS710B-1A-A	Pb-Free	Magazine case 50 pcs	Standard products	PS710B-1A
PS710BL-1A	PS710BL-1A-A			(UL approved)	
PS710BL-1A-E3	PS710BL-1A-E3-A		Embossed Tape 1 000 pcs/reel		
PS710BL-1A-E4	PS710BL-1A-E4-A				

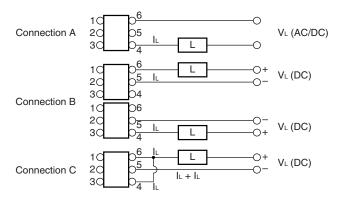
^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter			Symbol	Ratings	Unit	
Diode	Forward Current (DC)		lf	50	mA	
	Reverse Voltage		VR	5.0	٧	
	Power Dissipation		Po	50	mW	
	Peak Forward Current ^{*1}		IFP	1	Α	
MOS FET	Load Voltage		VL	60	٧	
	Continuous	Connection A	lL	2.5	Α	
	Load Current*2	Connection B		3.5		
		Connection C		5.0		
	Pulse Load Current *3 (AC/DC Connection)		ILP	5.0	Α	
	Power Dissipation		Po	625	mW	
Isolation Voltage *4			BV	1 500	Vr.m.s.	
Total Power Dissipation			P⊤	675	mW	
Operating Ambient Temperature			TA	-40 to +85	°C	
Storage Temperature			T _{stg}	-40 to +100	°C	

^{*1} PW = 100 μ s, Duty Cycle = 1%

*2 Conditions: If \geq 2 mA. The following types of load connections are available.



- *3 PW = 100 ms, 1 shot
- *4 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output Pins 1-3 shorted together, 4-6 shorted together.

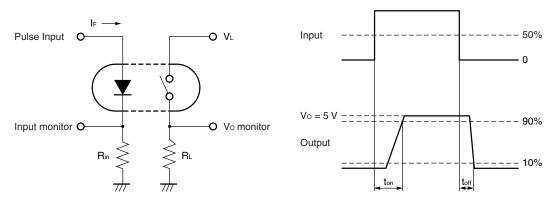
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lf	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lr	V _R = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	ILoff	V _D = 60 V			50	nA
	Output Capacitance	Cout	V _D = 0 V, f = 1 MHz		500		pF
Coupled	LED On-state Current	IFon	IL = 2.5 A			2.0	mA
	On-state Resistance	Ron	$I_F = 10 \text{ mA}, I_L = 2.5 \text{ A}, t \le 10 \text{ ms}$		0.05	0.1	Ω
	Turn-on Time *1, 2	ton	IF = 10 mA, Vo = 5 V, RL = 500 Ω ,		2.5	5.0	ms
	Turn-off Time *1, 2	toff	PW ≥ 10 ms		0.05	0.2	
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10°			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.5		pF

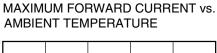
*1 Test Circuit for Switching Time

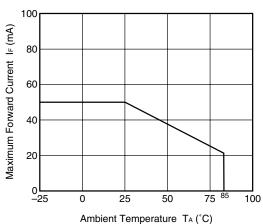


*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.

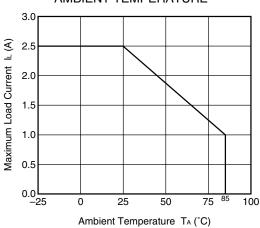
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

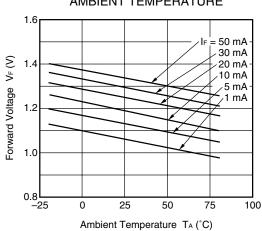




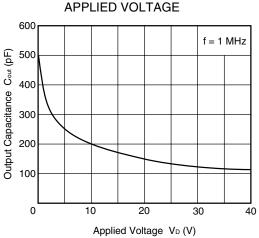
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



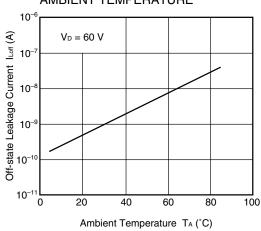
FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



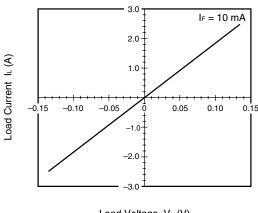
OUTPUT CAPACITANCE vs.



OFF-STATE LEAKAGE CURRENT vs. AMBIENT TEMPERATURE



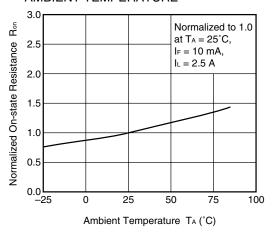
LOAD CURRENT vs. LOAD VOLTAGE



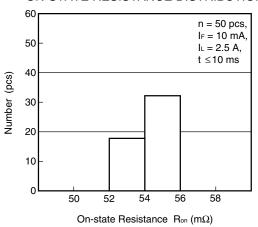
Load Voltage V_L (V)

Remark The graphs indicate nominal characteristics.

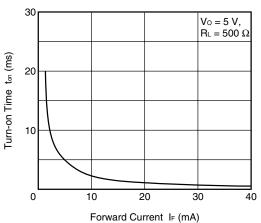
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



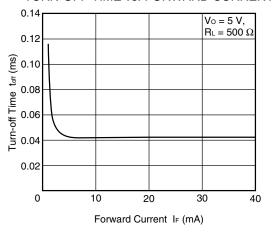
ON-STATE RESISTANCE DISTRIBUTION



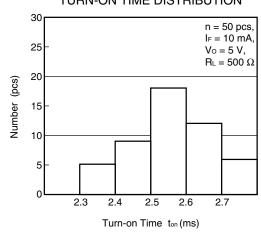
TURN-ON TIME vs. FORWARD CURRENT



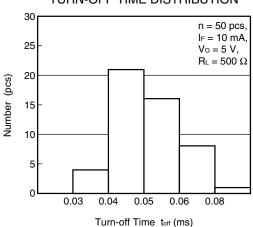
TURN-OFF TIME vs. FORWARD CURRENT



TURN-ON TIME DISTRIBUTION

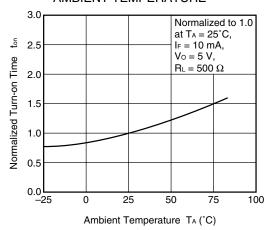


TURN-OFF TIME DISTRIBUTION



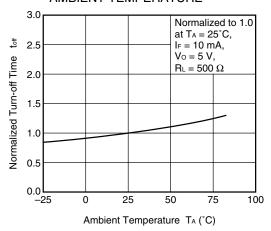
Remark The graphs indicate nominal characteristics.

NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

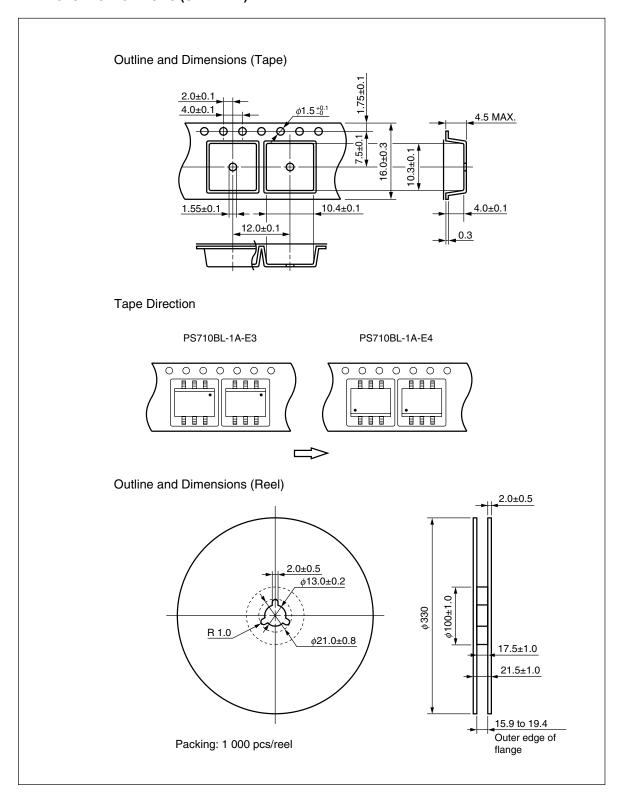


Remark The graphs indicate nominal characteristics.

NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

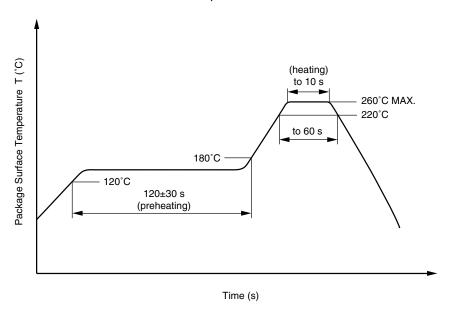
Time of peak reflow temperature
 Time of temperature higher than 220°C
 50 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine)

content of 0.2 Wt% is recommended.)

<R> (3) Soldering by soldering iron

Peak temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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